

ROHM's Selection Operational Amplifier/Comparator Series

Comparators: Ground Sense

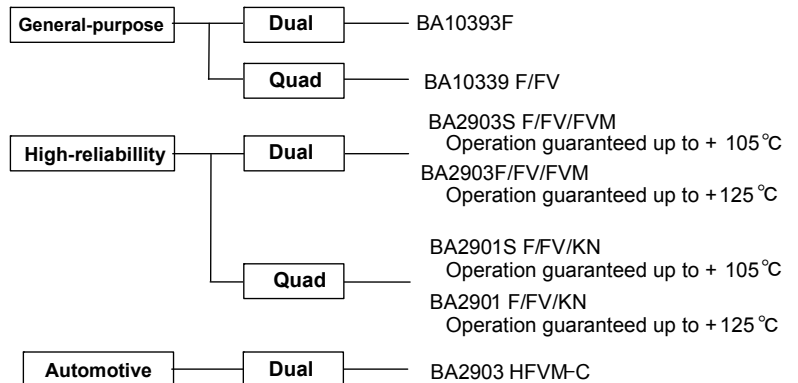
**BA10393F, BA10339F/FV, BA2903SF/FV/FVM, BA2903F/FV/FVM,
BA2903HFVM-C, BA2901S F/FV/KN, BA2901F/FV/KN**

No.09049EAT04



●Description

General purpose BA10393/BA10339 family and high reliability BA2903S/BA2903/BA2901S/BA2901 family and automotive BA2903HFVM-C integrate two or four independent high gain voltage comparator. Some features are the wide operating voltage that is 2 to 36[V] (for BA10393, BA2903S, BA2903, BA2901S, BA2901 family, BA2903HFVM-C), 3 to 36[V] (for BA10339 family) and low supply current. Therefore, this series is suitable for any application.

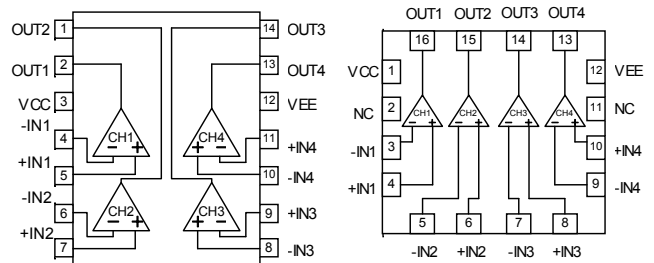
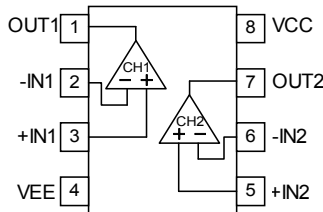


●Characteristics

- Operable with a single power supply
- Wide operating supply voltage

+2.0[V] ~ +36.0[V] (single supply)	{ BA10393 family }
±1.0[V] ~ ±18.0[V] (dual supply)	
+3.0[V] ~ +36.0[V] (single supply)	{ BA10339 family }
±1.5[V] ~ ±18.0[V] (dual supply)	
+2.0[V] ~ +36.0[V] (single supply)	{ BA2903S/BA2901S family BA2903 /BA2901 family BA2903H }
±1.0[V] ~ ±18.0[V] (dual supply)	
- Standard comparator pin-assignments
- Input and output are operable GND sense
- Internal ESD protection
Human body model (HBM) ±5000[V] (Typ.)
(BA2903S/BA2903/BA2901S/BA2901 family, BA2903HFVM-C)
- Gold PAD
(BA2903S/BA2903/BA2901S/BA2901 family, BA2903HFVM-C)
- Wide temperature range
-40[°C] ~ +125[°C] (BA2903/BA2901 family, BA2903HFVM-C)
-40[°C] ~ +105[°C] (BA2903S/BA2901S family)
-40[°C] ~ +85[°C] (BA10393/BA10339 family)

●Pin Assignment



SOP8

BA10393F
BA2903SF
BA2903F

SSOP-B8

BA2903SFV
BA2903FV

MSOP8

BA2903SFVM
BA2903FVM
BA2903HFVM-C

SOP14

BA10339F
BA2901SF
BA2901F

SSOP-B14

BA10339FV
BA2901SFV
BA2901FV

VQFN16

BA2901SKN
BA2901KN

●Absolute Maximum Ratings (Ta=25[°C])

Parameter	Symbol	Rating					Unit
		BA10393 family	BA10339 family	BA2903S family BA2901S family	BA2903 family BA2901 family	BA2903H family	
Supply Voltage	VCC-VEE	+36					V
Differential Input Voltage ^(*)	Vid	VCC-VEE			36		V
Input Common-mode Voltage Range	Vicm	VEE~VCC			(VEE-0.3)~VEE+36		V
Operating Temperature Range	Topr	-40~+85			-40~+105	-40~+125	°C
Storage Temperature Range	Tstg	-55~+125			-55~+150		°C
Maximum junction Temperature	Tjmax	+125			+150		°C

Note Absolute maximum rating item indicates the condition which must not be exceeded.

Application if voltage in excess of absolute maximum rating or use out of absolute maximum rated temperature environment may cause deterioration of characteristics.

(*) The voltage difference between inverting input and non-inverting input is the differential input voltage.
Then input terminal voltage is set to more than VEE.

●Electric Characteristics

OBA10393 family (Unless otherwise specified VCC=+5[V], VEE=0[V], Ta=25[°C])

Parameter	Symbol	Temperature range	Guaranteed limit			Unit	Condition
			Min.	Typ.	Max.		
Input Offset Voltage	Vio	25°C	-	±1	±5	mV	VOUT=1.4[V]
Input Offset Current	Iio	25°C	-	±5	±50	nA	VOUT=1.4[V]
Input Bias Current ^(*)	Ib	25°C	-	50	250	nA	VOUT=1.4[V]
Input Common-mode Voltage Range	Vicm	25°C	0	-	VCC-1.5	V	-
Large Signal Voltage Gain	AV	25°C	93	106	-	dB	RL=15[kΩ], VCC=15[V]
Supply Current	ICC	25°C	-	0.4	1	mA	RL=∞All Comparators
Output Sink Current	IOL	25°C	6	16	-	mA	VIN=-1[V], VIN+=0[V], VOUT=1.5[V]
Output Saturation Voltage	VOL	25°C	-	250	400	mV	VIN=-1[V], VIN+=0[V], IOL=4[mA]
Output Leakage Current 1	Ileak1	25°C	-	0.1	-	μA	VIN=0[V], VIN+=1[V], VOUT=5[V]
Output Leakage Current 2	Ileak2	25°C	-	0.1	1	μA	VIN=0[V], VIN+=1[V], VOUT=36[V]
Response Time	Tre	25°C	-	1.3	-	μs	RL=5.1[kΩ], VRL=5[V]

(*)Current Direction : Since first input stage is composed with PNP transistor, input bias current flows out of IC.

OBA10339 family (Unless otherwise specified VCC=+5[V], VEE=0[V], Ta=25[°C])

Parameter	Symbol	Temperature range	Guaranteed limit			Unit	Condition
			Min.	Typ.	Max.		
Input Offset Voltage	Vio	25°C	-	±1	±5	mV	VOUT=1.4[V]
Input Offset Current	Iio	25°C	-	±5	±50	nA	VOUT=1.4[V]
Input Bias Current ^(*)	Ib	25°C	-	50	250	nA	VOUT=1.4[V]
Input Common-mode Voltage Range	Vicm	25°C	0	-	VCC-1.5	V	-
Large Signal Voltage Gain	AV	25°C	-	106	-	dB	RL=15[kΩ], VCC=15[V]
Supply Current	ICC	25°C	-	0.8	2	mA	RL=∞All Comparators
Output Sink Current	IOL	25°C	6	16	-	mA	VIN=-1[V], VIN+=0[V], VOUT=1.5[V]
Output Saturation Voltage	VOL	25°C	-	250	400	mV	VIN=-1[V], VIN+=0[V], IOL=4[mA]
Output Leakage Current 1	Ileak1	25°C	-	0.1	-	μA	VIN=0[V], VIN+=1[V], VOUT=5[V]
Output Leakage Current 2	Ileak2	25°C	-	-	-	μA	VIN=0[V], VIN+=1[V], VOUT=36[V]
Response Time	Tre	25°C	-	1.3	-	μs	RL=5.1[kΩ], VRL=5[V]

(*)Current Direction : Since first input stage is composed with PNP transistor, input bias current flows out of IC.

OBA2903S/BA2903 family (Unless otherwise specified VCC=+5[V], VEE=0[V])

Parameter	Symbol	Temperature range	Guaranteed limit			Unit	Condition
			Min.	Typ.	Max.		
Input Offset Voltage ^{(*)3}	Vio	25°C	-	2	7	mV	VOUT=1.4[V]
		Full range ^{(*)4}	-	-	15		VCC=5~36[V], VOUT=1.4[V]
Input Offset Current ^{(*)3}	Iio	25°C	-	5	50	nA	VOUT=1.4[V]
		v	-	-	200		
Input Bias Current ^{(*)3}	Ib	25°C	-	50	250	nA	VOUT=1.4[V]
		Full range ^{(*)4}	-	-	500		
Input Common-mode Voltage Range	Vicm	25°C	0	-	VCC-1.5	V	-
		Full range ^{(*)4}	-	-	-		
Large Signal Voltage Gain	AV	25°C	88	100	-	dB	VCC=15[V], VOUT=1.4~11.4[V] RL=15[kΩ], VRL=15[V]
		Full range ^{(*)4}	-	-	-		
Supply Current	ICC	25°C	-	0.6	1	mA	VOUT=open
		Full range ^{(*)4}	-	-	2.5		VOUT=open, VCC=36[V]
Output Sink Current ^{(*)4}	IOL	25°C	6	16	-	mA	VIN+=0[V], VIN-=1[V], VOL=1.5[V]
Output Saturation Voltage (Low Level Output Voltage)	VOL	25°C	-	150	400	mV	VIN+=0[V], VIN-=1[V], IOL=4[mA]
		Full range ^{(*)4}	-	-	700		
Output Leakage Current (High Level Output Current)	Ileak	25°C	-	0.1	-	nA	VIN+=1[V], VIN-=0[V], VOH=5[V]
		Full range ^{(*)4}	-	-	1	μA	VIN+=1[V], VIN-=0[V], VOH=36[V]
Response Time	Tre	25°C	-	1.3	-	μs	RL=5.1[kΩ], VRL=5[V] VIN=100[mVp-p], overdrive=5[mV]
			-	0.4	-		RL=5.1[kΩ], VRL=5[V], VIN=TTL Logic Swing, VREF=1.4[V]
Operable Frequency	Fopr	25°C	-	-	-	kHz	VCC=5[V], RL=2[kΩ], VIN+=1.5[V] VIN-=5[Vp-p] (Duty 50% Rectangular Pulse)

(*)3 Absolute value

(*)4 BA2903S family : Full range -40[°C]~+105[°C]

(*)4 BA2903 family : Full range -40[°C]~+125[°C]

OBBA2901S/BA2901 family (Unless otherwise specified VCC=+5[V], VEE=0[V])

Parameter	Symbol	Temperature range	Guaranteed limit			Unit	Condition
			Min.	Typ.	Max.		
Input Offset Voltage ^{(*)3}	Vio	25°C	-	2	7	mV	VOUT=1.4[V]
		Full range ^{(*)4}	-	-	15		VCC=5~36[V], VOUT=1.4[V]
Input Offset Current ^{(*)3}	Iio	25°C	-	5	50	nA	VOUT=1.4[V]
		v	-	-	200		
Input Bias Current ^{(*)3}	Ib	25°C	-	50	250	nA	VOUT=1.4[V]
		Full range ^{(*)4}	-	-	500		
Input Common-mode Voltage Range	Vicm	25°C	0	-	VCC-1.5	V	-
		Full range ^{(*)4}	-	-	-		
Large Signal Voltage Gain	AV	25°C	88	100	-	dB	VCC=15[V], VOUT=1.4~11.4[V] RL=15[kΩ], VRL=15[V]
		Full range ^{(*)4}	-	-	-		
Supply Current	ICC	25°C	-	0.8	2	mA	VOUT=open
		Full range ^{(*)4}	-	-	2.5		VOUT=open, VCC=36[V]
Output Sink Current ^{(*)4}	IOL	25°C	6	16	-	mA	VIN+=0[V], VIN-=1[V], VOL=1.5[V]
Output Saturation Voltage (Low Level Output Voltage)	VOL	25°C	-	150	400	mV	VIN+=0[V], VIN-=1[V], IOL=4[mA]
		Full range ^{(*)4}	-	-	700		
Output Leakage Current (High Level Output Current)	Ileak	25°C	-	0.1	-	nA	VIN+=1[V], VIN-=0[V], VOH=5[V]
		Full range ^{(*)4}	-	-	1	μA	VIN+=1[V], VIN-=0[V], VOH=36[V]
Response Time	Tre	25°C	-	1.3	-	μs	RL=5.1[kΩ], VRL=5[V] VIN=100[mVp-p], overdrive=5[mV]
			-	0.4	-		RL=5.1[kΩ], VRL=5[V], VIN=TTL Logic Swing, VREF=1.4[V]
Operable Frequency	Fopr	25°C	-	-	-	kHz	VCC=5[V], RL=2[kΩ], VIN+=1.5[V] VIN-=5[Vp-p] (Duty 50% Rectangular Pulse)

(*)3 Absolute value

(*)4 BA2901S family : Full range -40[°C]~+105[°C]

(*)4 BA2901 family : Full range -40[°C]~+125[°C]

OBA2903HFVM-C (Unless otherwise specified VCC=+5[V], VEE=0[V])

Parameter	Symbol	Temperature range	Guaranteed limit			Unit	Condition
			Min.	Typ.	Max.		
Input Offset Voltage ^{(*)3}	Vio	25°C	-	2	5	mV	VOUT=1.4[V]
		Full range ^{(*)4}	-	-	15		VCC=5~36[V],VOUT=1.4[V]
Input Offset Current ^{(*)3}	Iio	25°C	-	5	50	nA	VOUT=1.4[V]
		v	-	-	200		
Input Bias Current ^{(*)3}	Ib	25°C	-	50	250	nA	VOUT=1.4[V]
		Full range ^{(*)4}	-	-	500		
Input Common-mode Voltage Range	Vicm	25°C	0	-	VCC-1.5	V	-
		Full range ^{(*)4}	0	-	VCC-2.0		
Large Signal Voltage Gain	AV	25°C	88	100	-	dB	VCC=15[V],VOUT=1.4~11.4[V] RL=15[kΩ],VRL=15[V]
		Full range ^{(*)4}	74	-	-		
Supply Current	ICC	25°C	-	0.6	1	mA	VOUT=open
		Full range ^{(*)4}	-	-	2.5		VOUT=open,VCC=36[V]
Output Sink Current ^{(*)4}	IOL	25°C	6	16	-	mA	VIN+=0[V],VIN-=1[V],VOL=1.5[V]
Output Saturation Voltage (Low Level Output Voltage)	VOL	25°C	-	150	400	mV	VIN+=0[V],VIN-=1[V],IOL=4[mA]
		Full range ^{(*)4}	-	-	700		
Output Leakage Current (High Level Output Current)	Ileak	25°C	-	0.1	-	nA	VIN+=1[V],VIN-=0[V],VOH=5[V]
		Full range ^{(*)4}	-	-	1	μA	VIN+=1[V],VIN-=0[V],VOH=36[V]
Response Time	Tre	25°C	-	-	-	μs	RL=5.1[kΩ],VRL=5[V] VIN=100[mVp-p],overdrive=5[mV]
			-	-	-		RL=5.1[kΩ],VRL=5[V],VIN=TTL Logic Swing,VREF=1.4[V]
Operable Frequency	Fopr	25°C	100	-	-	kHz	VCC=5[V],RL=2[kΩ], VIN+=1.5[V] VIN-=5[Vp-p] (Duty 50% Rectangular Pulse)

(*)3 Absolute value

(*)4 BA2903HFVM-C : Full range -40[°C]~+125[°C]

●Example of electrical characteristics(Refarence Data)

OBA10393 family

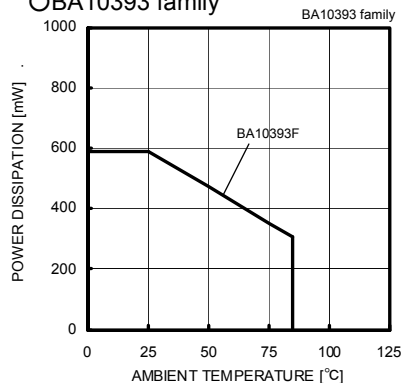


Fig. 1
Derating Curve

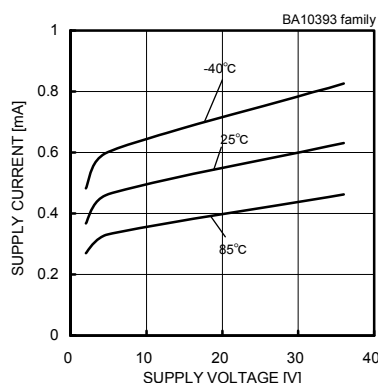


Fig. 2
Supply Current - Supply Voltage

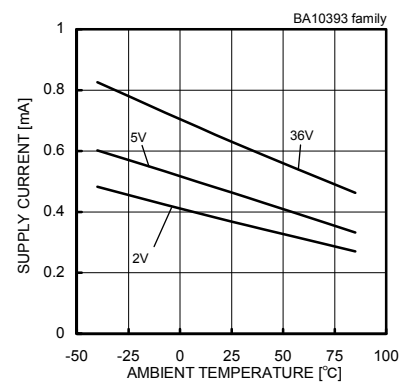


Fig. 3
Supply Current - Ambient Temperature

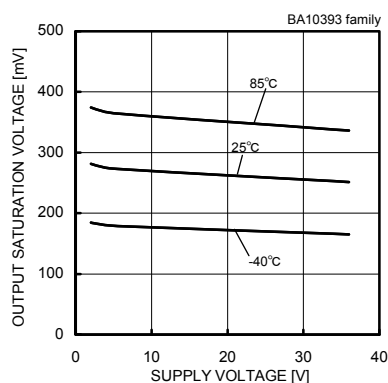


Fig. 4
Output Saturation Voltage - Supply Voltage
(IOL=4[mA])

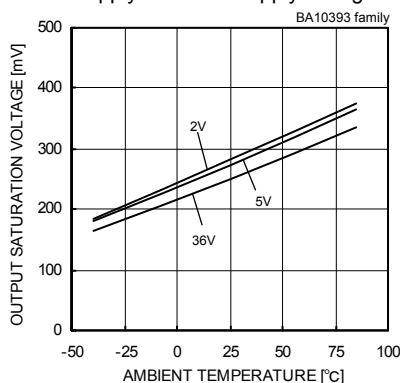


Fig. 5
Output Saturation Voltage - Ambient Temperature
(IOL=4[mA])

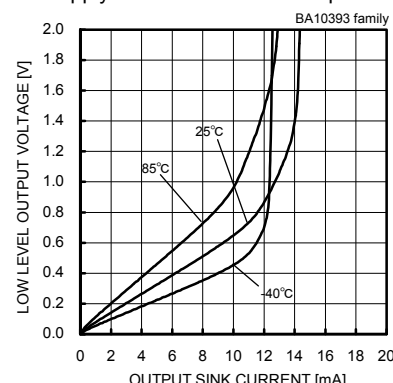


Fig. 6
Low Level Output Voltage - Output Sink Current
(VCC=5[V])

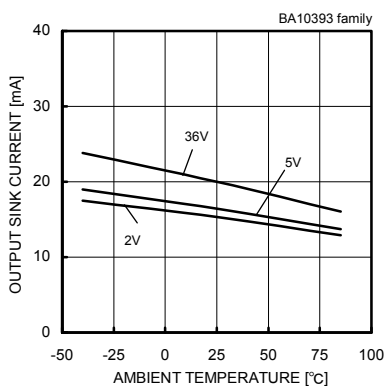


Fig. 7
Output Sink Current - Ambient Temperature
(VOUT=1.5[V])

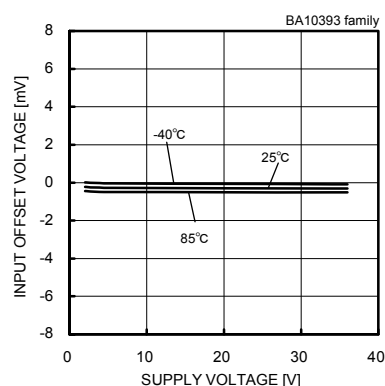


Fig. 8
Input Offset Voltage - Supply Voltage

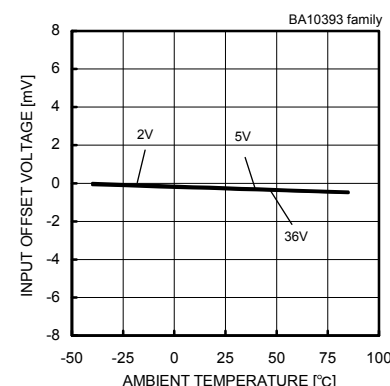


Fig. 9
Input Offset Voltage - Ambient Temperature

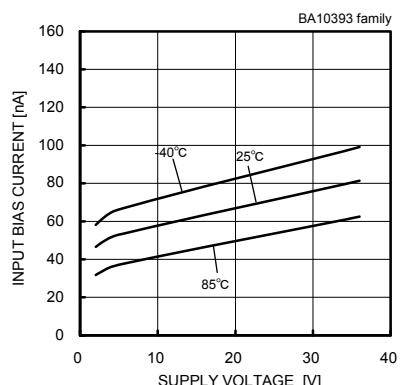


Fig. 10
Input Bias Current - Supply Voltage

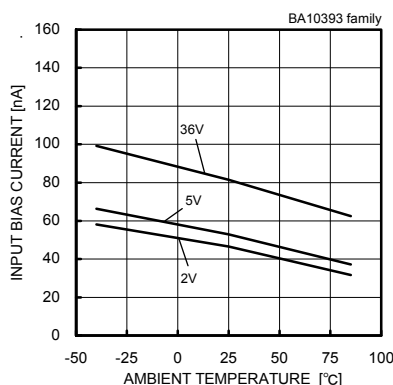


Fig. 11
Input Bias Current - Ambient Temperature

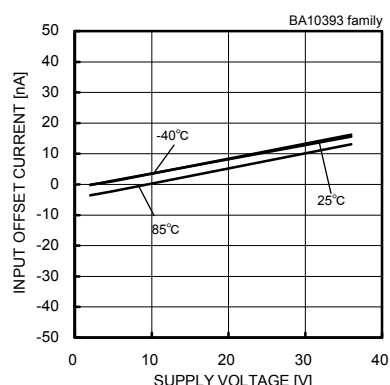


Fig. 12
Input Offset Current - Supply Voltage

(*)The data above is ability value of sample, it is not guaranteed.

○BA10393 family

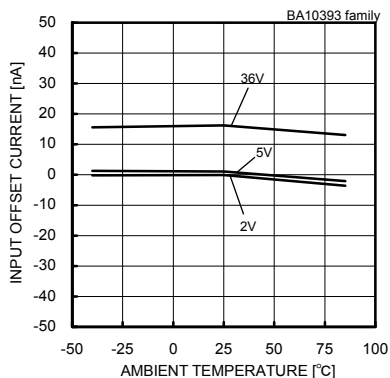


Fig. 13

Input Offset Current – Ambient Temperature

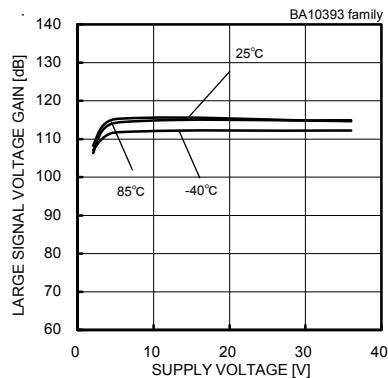


Fig. 14

Large Signal Voltage Gain
– Supply Voltage

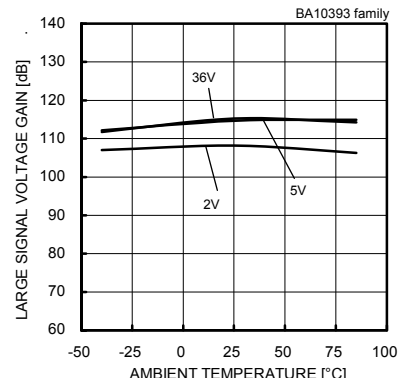


Fig. 15

Large Signal Voltage Gain
– Ambient Temperature

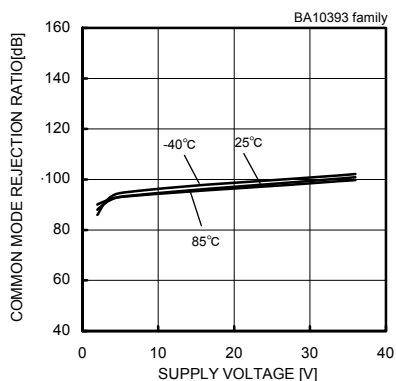


Fig. 16

Common Mode Rejection Ratio
– Supply Voltage

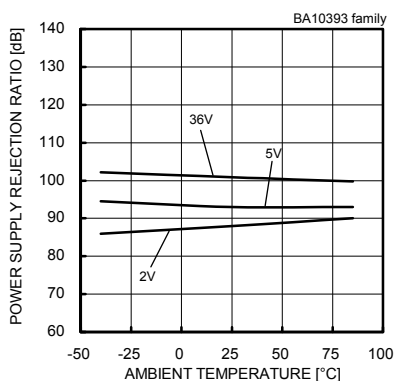


Fig. 17

Common Mode Rejection Ratio
– Ambient Temperature

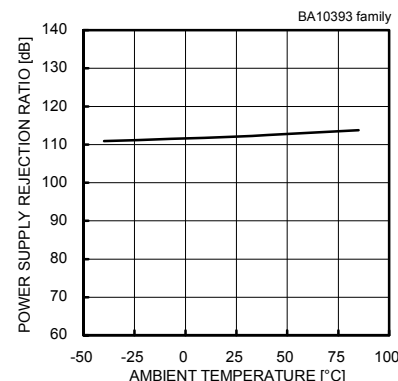


Fig. 18

Power Supply Rejection Ratio
– Ambient Temperature

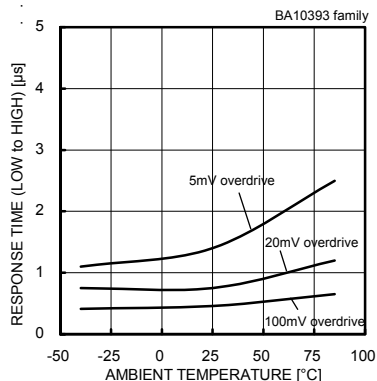


Fig. 19

Response Time (Low to High)
– Ambient Temperature
(VCC=5[V], VRL=5[V], RL=5.1[kΩ])

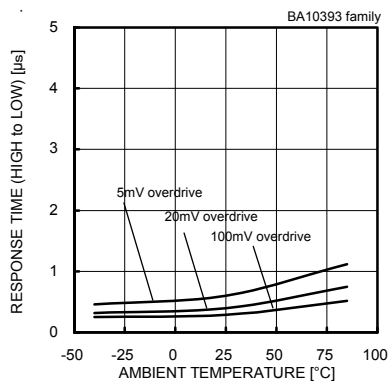


Fig. 20

Response Time (High to Low)
– Ambient Temperature
(VCC=5[V], VRL=5[V])

(*)The data above is ability value of sample, it is not guaranteed.

OBA10339 family

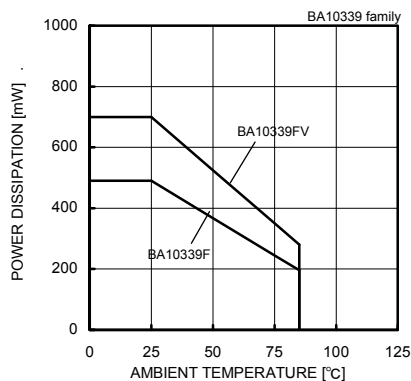


Fig. 21
Derating Curve

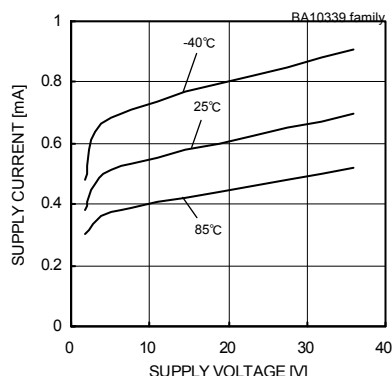


Fig. 22
Supply Current - Supply Voltage

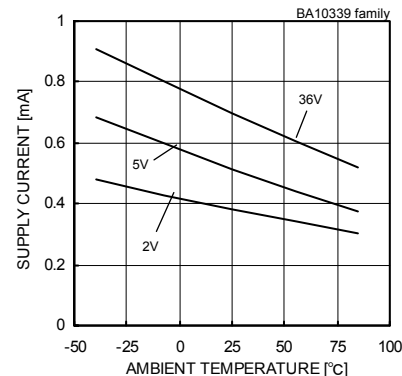


Fig. 23
Supply Current - Ambient Temperature

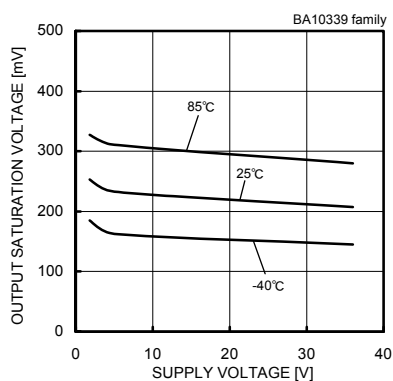


Fig. 24
Output Saturation Voltage - Supply Voltage
(IOL=4[mA])

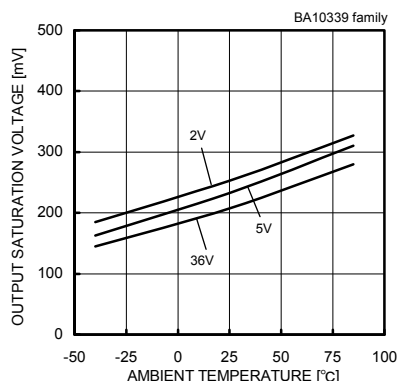


Fig. 25
Output Saturation Voltage - Ambient Temperature
(IOL=4[mA])

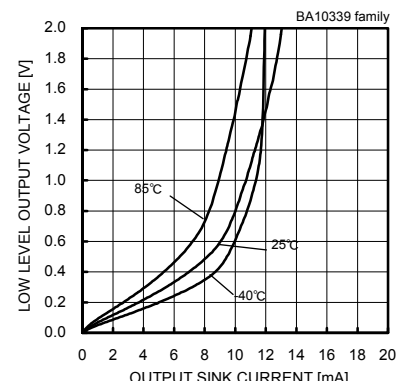


Fig. 26
Low Level Output Voltage
- Output Sink Current(VCC=5[V])

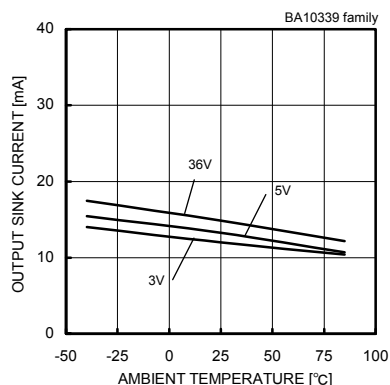


Fig. 27
Output Sink Current - Ambient Temperature
(VOUT=1.5[V])

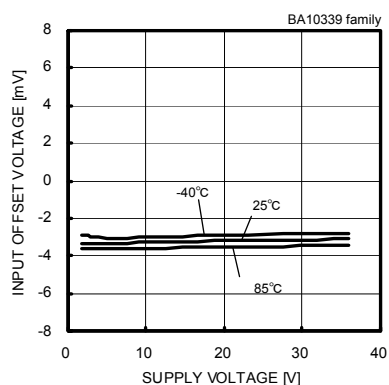


Fig. 28
Input Offset Voltage - Supply Voltage

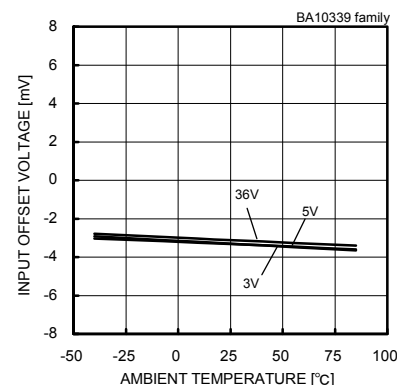


Fig. 29
Input Offset Voltage - Ambient Temperature

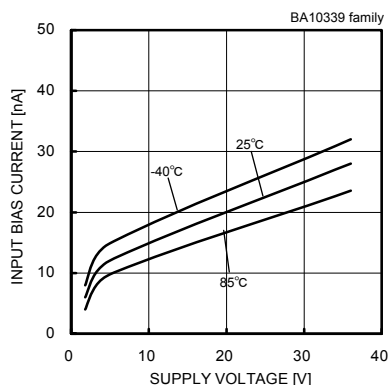


Fig. 30
Input Bias Current - Supply Voltage

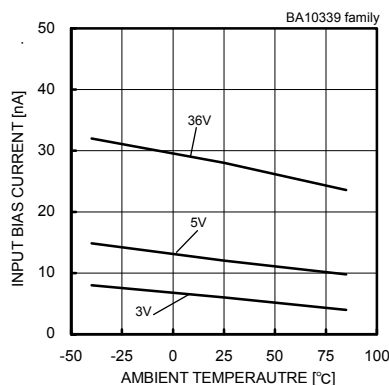


Fig. 31
Input Bias Current - Ambient Temperature

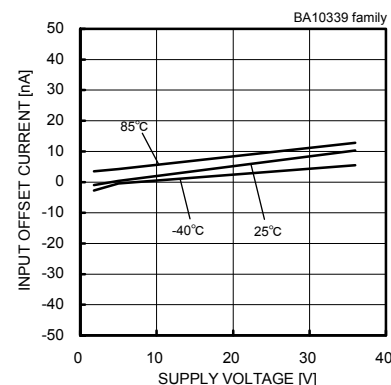


Fig. 32
Input Offset Current - Supply Voltage

(*)The data above is ability value of sample, it is not guaranteed.

○BA10339 family

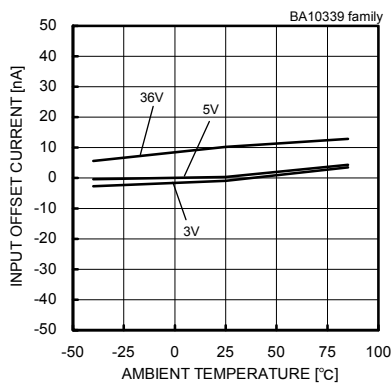


Fig. 33

Input Offset Current – Ambient Temperature

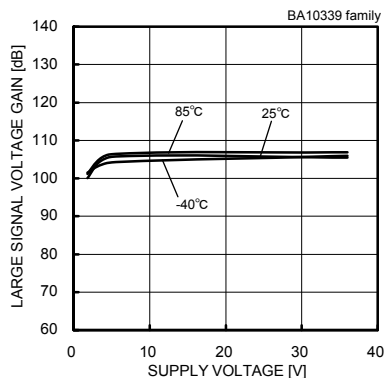


Fig. 34

Large Signal Voltage Gain
– Supply Voltage

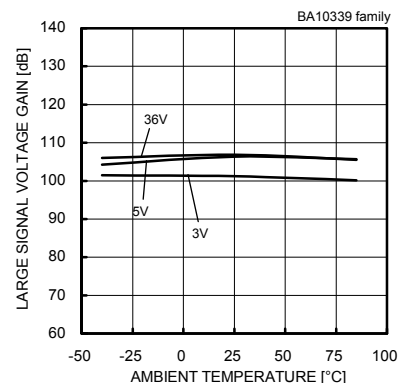


Fig. 35

Large Signal Voltage Gain
– Ambient Temperature

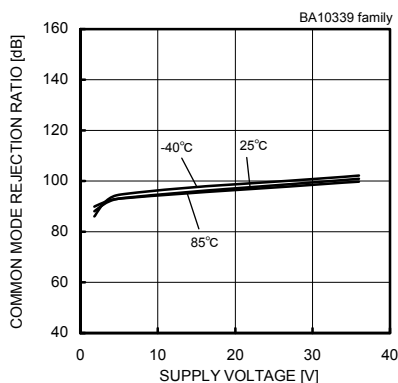


Fig. 36

Common Mode Rejection Ratio
– Supply Voltage

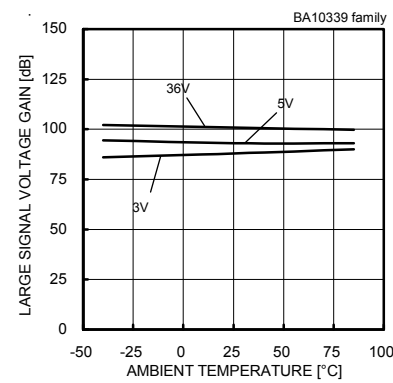


Fig. 37

Large Signal Voltage Gain
– Ambient Temperature

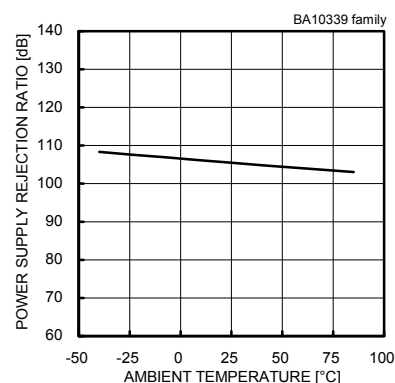


Fig. 38

Power Supply Rejection Ratio
– Ambient Temperature

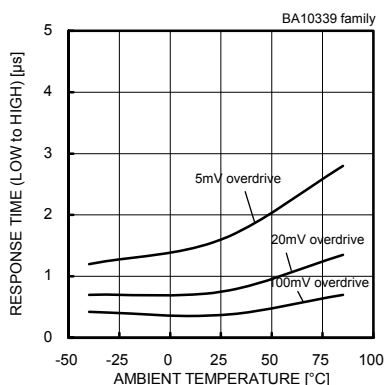


Fig. 39

Response Time (Low to High)
– Ambient Temperature
(VCC=5[V], VRL=5[V], RL=5.1[kΩ])

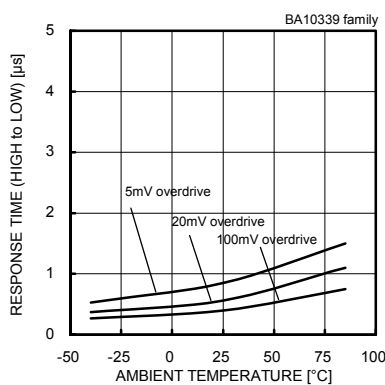


Fig. 40

Response Time (High to Low)
– Ambient Temperature
(VCC=5[V], VRL=5[V])

(*)The data above is ability value of sample, it is not guaranteed.

OBA2903S/BA2903 family,BA2903HFVM-C

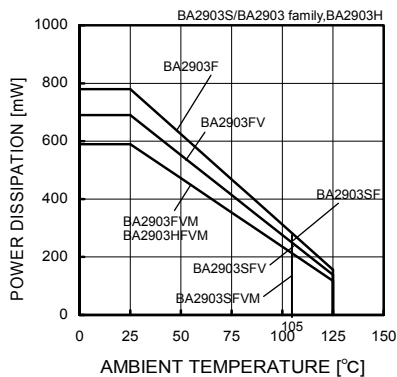


Fig. 41
Derating Curve

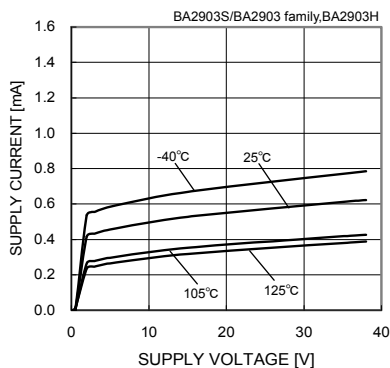


Fig. 42
Supply Current - Supply Voltage

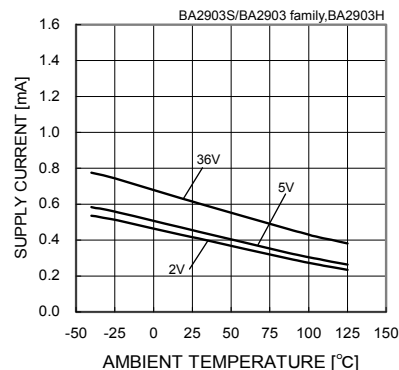


Fig. 43
Supply Current - Ambient Temperature

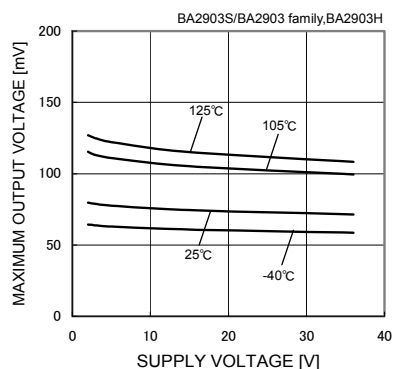


Fig. 44
Maximum Output Voltage
- Supply Voltage(IOL=4[mA])

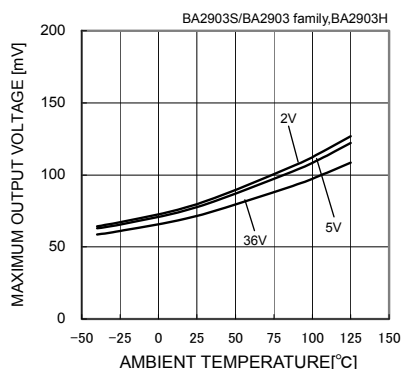


Fig. 45
Maximum Output Voltage
- Ambient Temperature(IOL=4[mA])

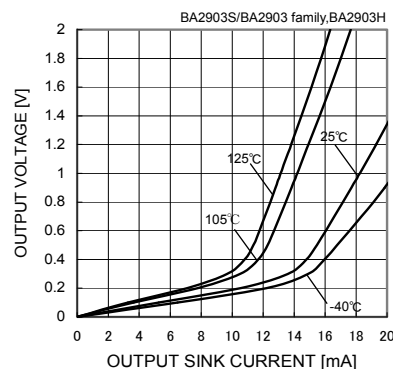


Fig. 46
Output Voltage
- Output Sink Current(VCC=5[V])

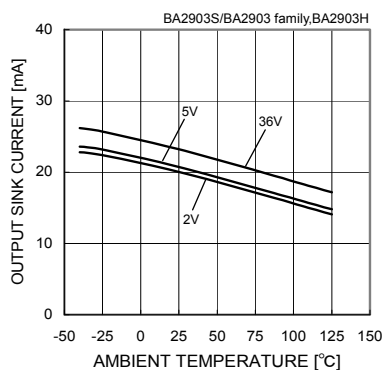


Fig. 47
Output Sink Current - Ambient Temperature
(VOUT=1.5[V])

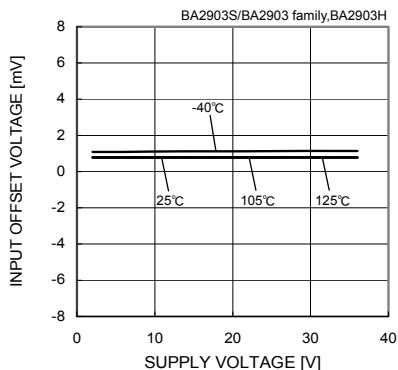


Fig. 48
Input Offset Voltage - Supply Voltage

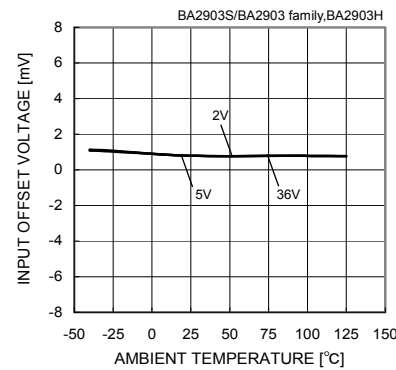


Fig. 49
Input Offset Voltage - Ambient Temperature

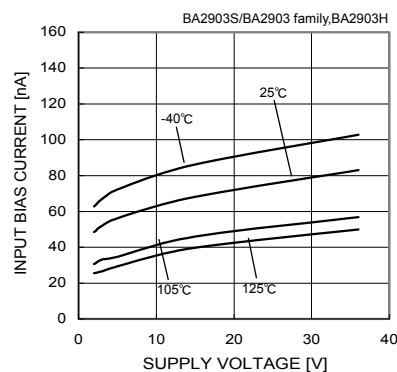


Fig. 50
Input Bias Current - Supply Voltage

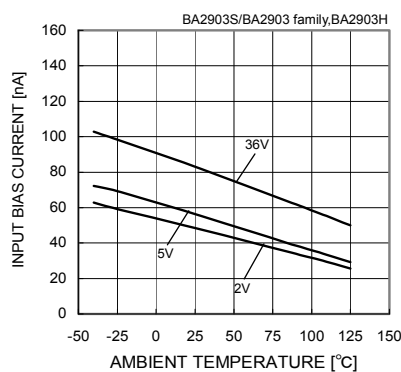


Fig. 51
Input Bias Current - Ambient Temperature

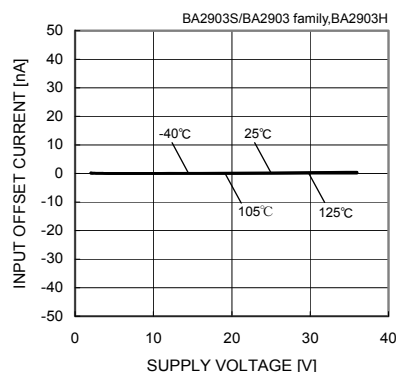


Fig. 52
Input Offset Current - Supply Voltage

(*)The data above is ability value of sample, it is not guaranteed.

○BA2903S/BA2903 family,BA2903HFVM-C

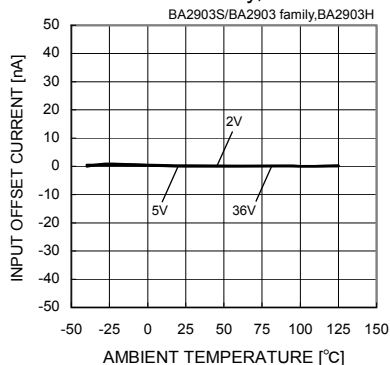


Fig. 53

Input Offset Current – Ambient Temperature

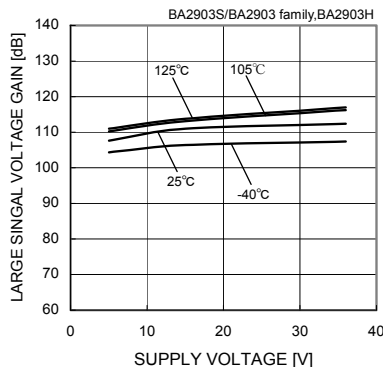


Fig. 54

Large Signal Voltage Gain
– Supply Voltage

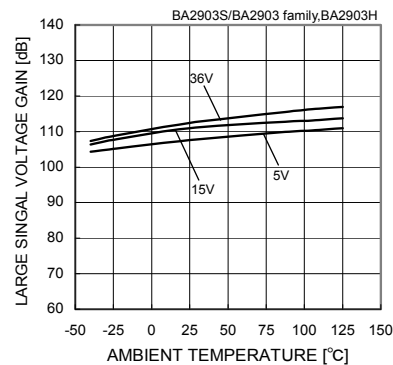


Fig. 55

Large Signal Voltage Gain
– Ambient Temperature

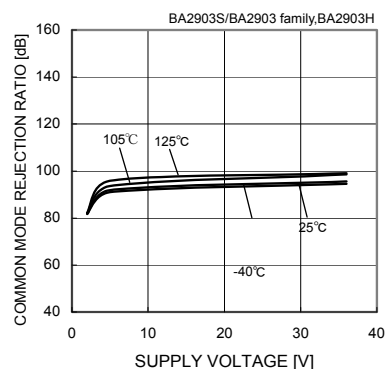


Fig. 56

Common Mode Rejection Ratio
– Supply Voltage

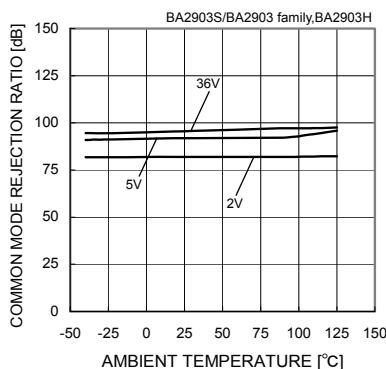


Fig. 57

Common Mode Rejection Ratio
– Ambient Temperature

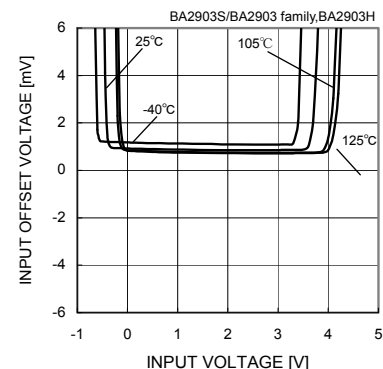


Fig. 58

Input Offset Voltage – Input Voltage
(VCC=5V)

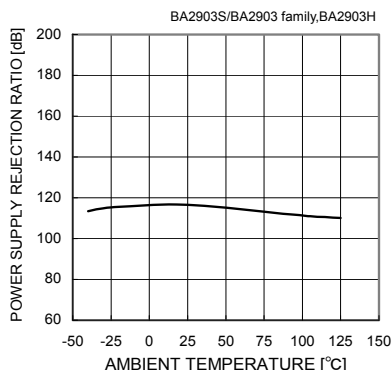


Fig. 59

Power Supply Rejection Ratio
– Ambient Temperature

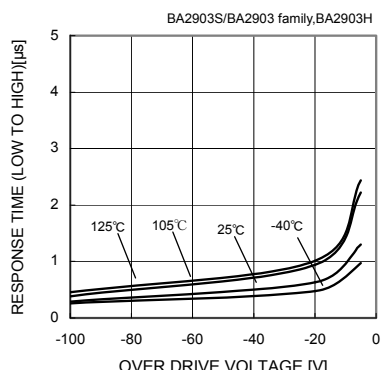


Fig. 60

Response Time (Low to High)
– Over Drive Voltage
(VCC=5[V], VRL=5[V], RL=5.1[kΩ])
BA2903S/BA2903 family,BA2903H

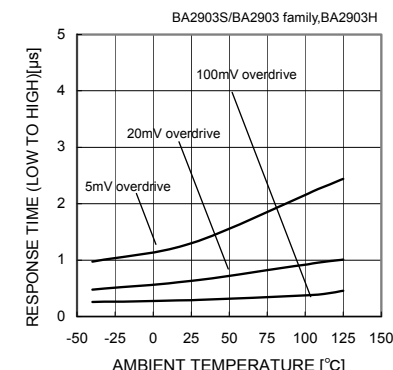


Fig. 61

Response Time (Low to High)
– Ambient Temperature
(VCC=5[V], VRL=5[V], RL=5.1[kΩ])

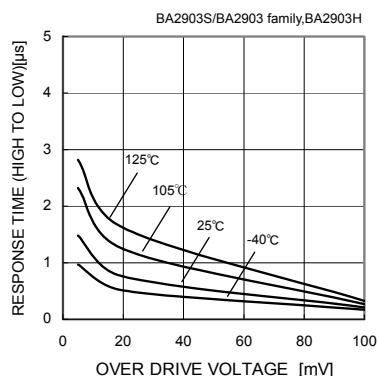


Fig. 62

Response Time (High to Low)– Over Drive Voltage
(VCC=5[V], VRL=5[V], RL=5.1[kΩ])

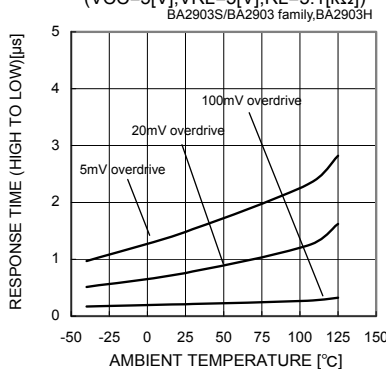


Fig. 63

Response Time (High to Low) – Ambient
Temperature (VCC=5[V], VRL=5[V], RL=5.1[kΩ])

(*)The data above is ability value of sample, it is not guaranteed.

OBA2901S/BA2901 family

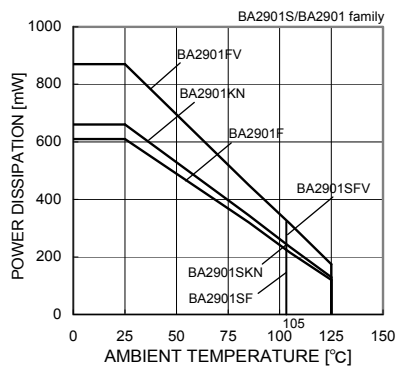


Fig. 64
Derating Curve

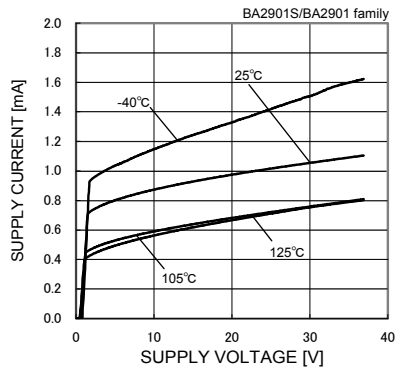


Fig. 65
Supply Current - Supply Voltage

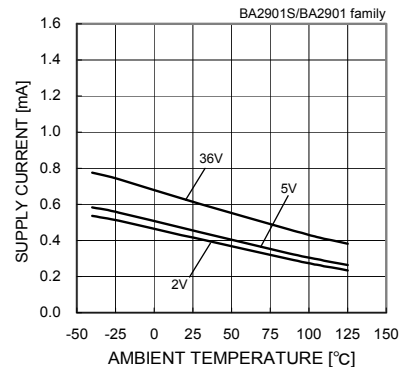


Fig. 66
Supply Current - Ambient Temperature

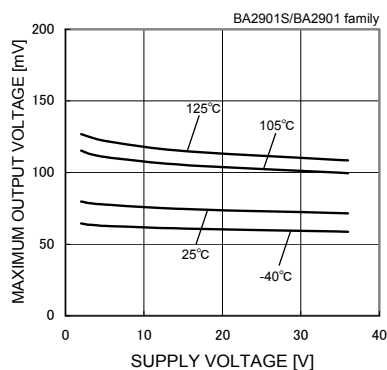


Fig. 67
Maximum Output Voltage
- Supply Voltage
(IOL=4[mA])

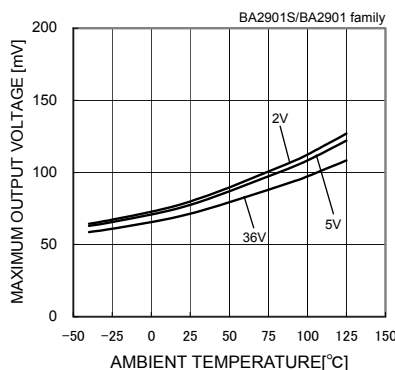


Fig. 68
Maximum Output Voltage
- Ambient Temperature
(IOL=4[mA])

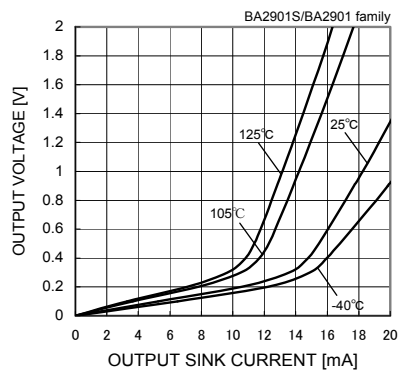


Fig. 69
Output Voltage
- Output Sink Current
(VCC=5[V])

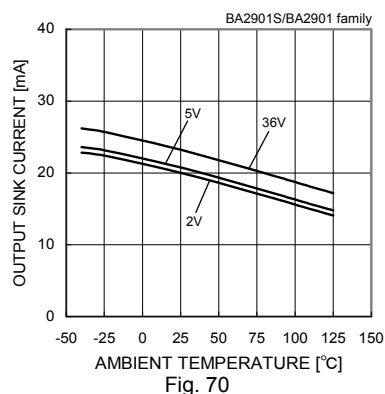


Fig. 70
Output Sink Current - Ambient Temperature
(VOUT=1.5[V])

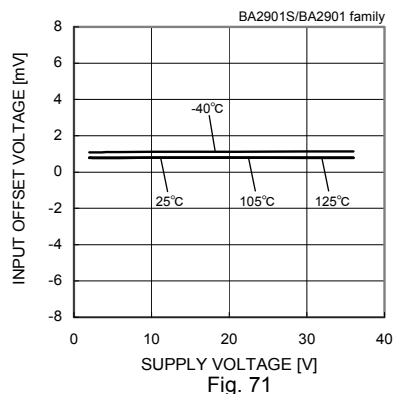


Fig. 71
Input Offset Voltage - Supply Voltage

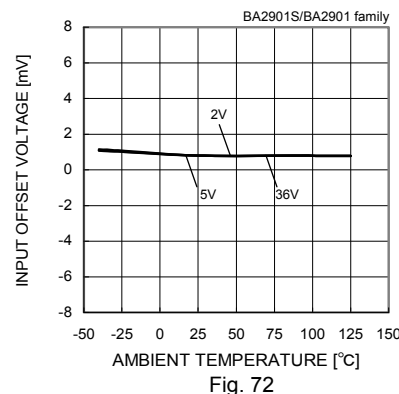


Fig. 72
Input Offset Voltage - Ambient Temperature

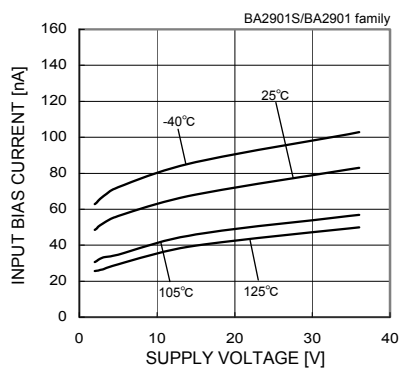


Fig. 73
Input Bias Current - Supply Voltage

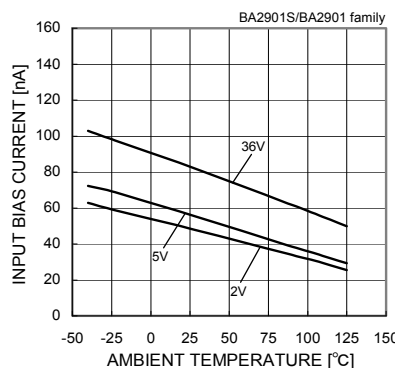


Fig. 74
Input Bias Current - Ambient Temperature

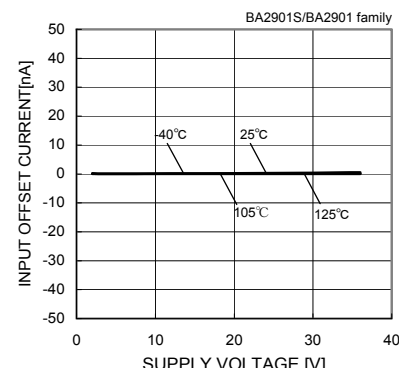


Fig. 75
Input Offset Current - Supply Voltage

(*)The data above is ability value of sample, it is not guaranteed.

OBA2901S/BA2901 family

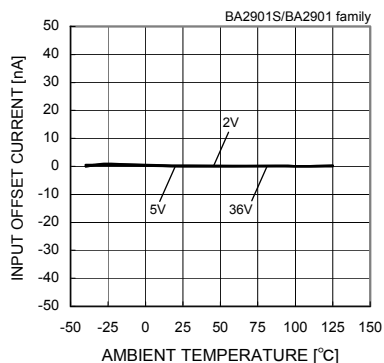


Fig. 76

Input Offset Current – Ambient Temperature

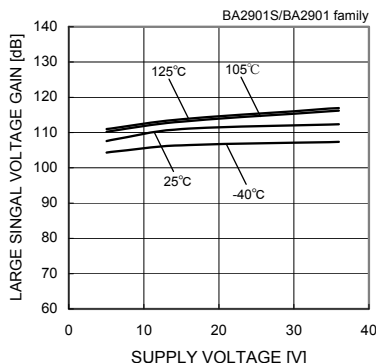


Fig. 77

Large Signal Voltage Gain
– Supply Voltage

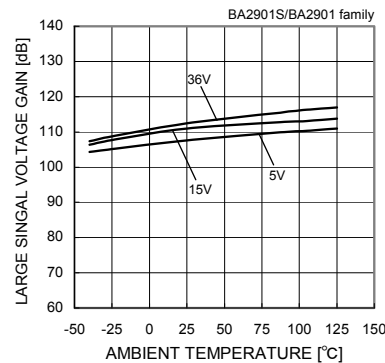


Fig. 78

Large Signal Voltage Gain
– Ambient Temperature

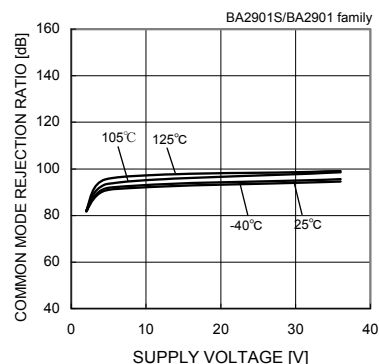


Fig. 79

Common Mode Rejection Ratio
– Supply Voltage

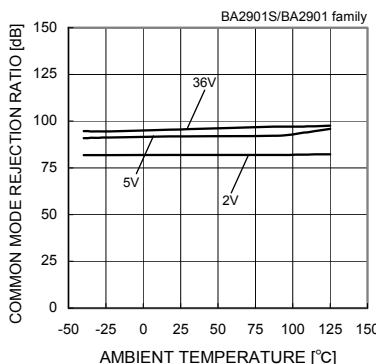


Fig. 80

Common Mode Rejection Ratio
– Ambient Temperature

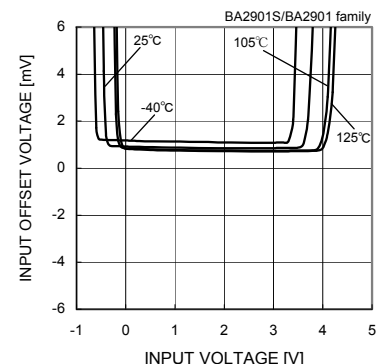


Fig. 81

Input Offset Voltage - Input Voltage
(VCC=5V)

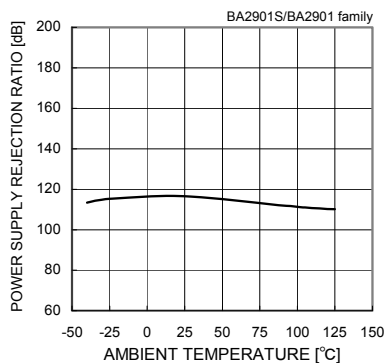


Fig. 82

Power Supply Rejection Ratio
– Ambient Temperature

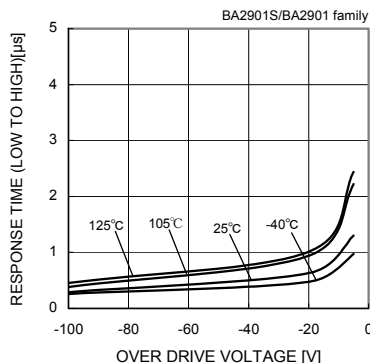


Fig. 83

Response Time (Low to High)
– Over Drive Voltage
(VCC=5[V], VRL=5[V], RL=5.1[kΩ])

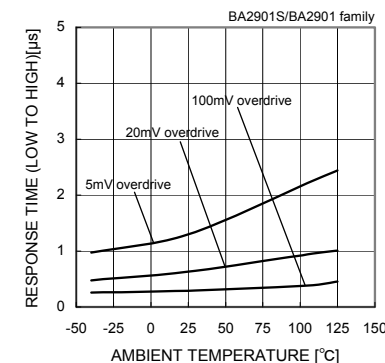


Fig. 84

Response Time (Low to High)
– Ambient Temperature
(VCC=5[V], VRL=5[V], RL=5.1[kΩ])

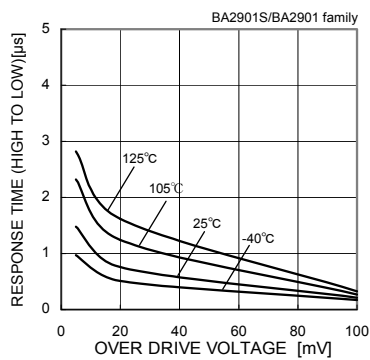


Fig. 85

Response Time (High to Low)
– Over Drive Voltage
(VCC=5[V], VRL=5[V], RL=5.1[kΩ])

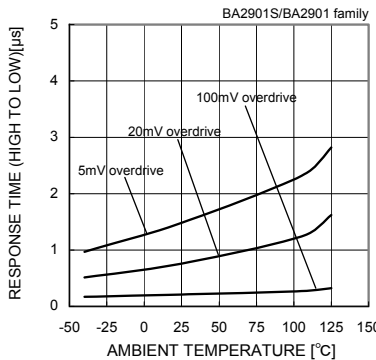


Fig. 86

Response Time (High to Low)
– Ambient Temperature
(VCC=5[V], VRL=5[V], RL=5.1[kΩ])

(*)The data above is ability value of sample, it is not guaranteed.

●Circuit Diagram

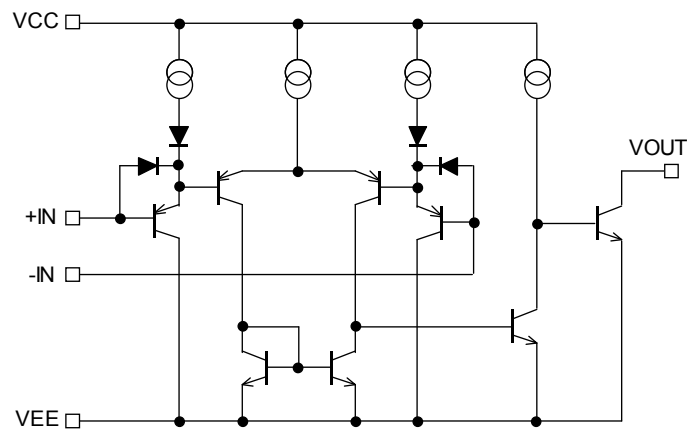


Fig.87 Circuit Diagram (one channel only)

●Test Circuit1 Null Method
VCC,VEE,EK,Vicm Unit : [V], VRL=VCC

Parameter	VF	S1	S2	S3	BA10393/BA10339 family				BA2903S/BA2901S family BA2903/BA2901 family BA2903HFVM-C				Calculation
					Vcc	GND	EK	Vicm	Vcc	GND	EK	Vicm	
Input Offset Voltage	VF1	ON	ON	ON	5	0	-1.4	0	5~36	0	-1.4	0	1
Input Offset Current	VF2	OFF	OFF	ON	5	0	-1.4	0	5	0	-1.4	0	2
Input Bias Current	VF3	OFF	ON	ON	5	0	-1.4	0	5	0	-1.4	0	3
	VF4	ON	OFF		5	0	-1.4	0	5	0	-1.4	0	
Large Signal Voltage Gain	VF5	ON	ON	ON	15	0	-1.4	0	15	0	-1.4	0	4
	VF6				15	0	-11.4	0	15	0	-11.4	0	

-Calculation-

1. Input Offset Voltage (Vio)

$$V_{io} = \frac{|VF1|}{1+ R_f/R_s} \text{ [V]}$$

2. Input Offset Current (Iio)

$$I_{io} = \frac{|VF2 - VF1|}{R_i(1+ R_f / R_s)} \text{ [A]}$$

3. Input Bias Current (Ib)

$$I_b = \frac{|VF4 - VF3|}{2 \times R_i(1+ R_f / R_s)} \text{ [A]}$$

4. Large Signal Voltage Gain (AV)

$$A_v = 20 \times \text{Log} \frac{\Delta E_K \times (1+R_f/R_s)}{|VF5-VF6|} \text{ [dB]}$$

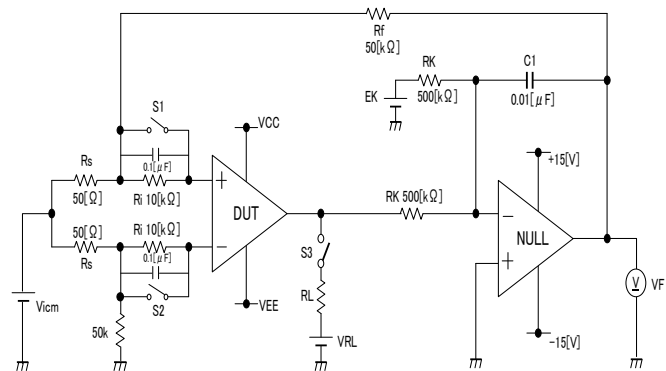


Fig.88 Measurement circuit1 (one channel only)

●Measurement Circuit 2: Switch Condition

SW No.		SW 1	SW 2	SW 3	SW 4	SW 5	SW 6	SW 7
Supply Current		OFF	OFF	OFF	OFF	OFF	OFF	OFF
Output Sink Current	VOL=1.5[V]	OFF	ON	ON	OFF	OFF	OFF	ON
Saturation Voltage	IOL=4[mA]	OFF	ON	ON	OFF	ON	ON	OFF
Output Leakage Current	VOH=36[V]	OFF	ON	ON	OFF	OFF	OFF	ON
Response Time	RL=5.1[kΩ], VRL=5[V]	ON	OFF	ON	ON	OFF	OFF	OFF

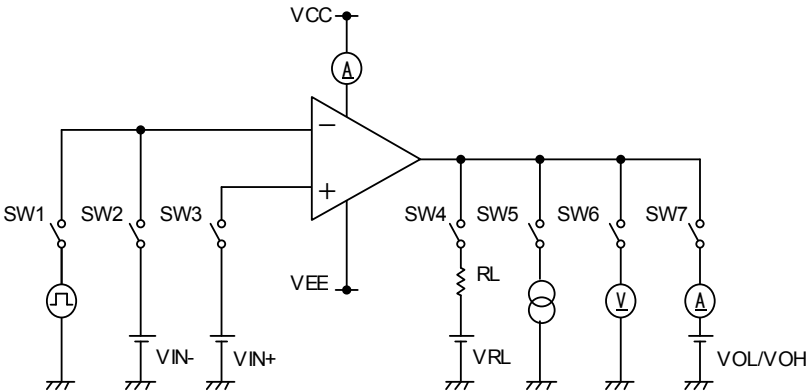


Fig.89 Measurement Circuit 2 (one channel only)

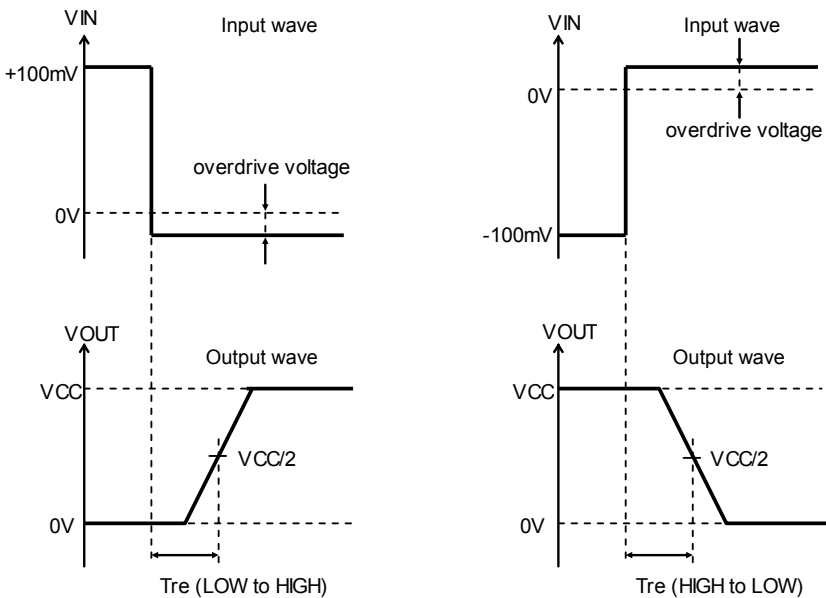


Fig.90 Response Time

●Description of electrical characteristics

Described below are descriptions of the relevant electrical terms.

Please note that item names, symbols, and their meanings may differ from those on another manufacturer's documents.

1. Absolute maximum ratings

The absolute maximum ratings are values that should never be exceeded, since doing so may result in deterioration of electrical characteristics or damage to the part itself as well as peripheral components.

1.1 Power supply voltage (VCC/VEE)

Expresses the maximum voltage that can be supplied between the positive and negative power supply terminals without causing deterioration of the electrical characteristics or destruction of the internal circuitry.

1.2 Differential input voltage (Vid)

Indicates the maximum voltage that can be supplied between the non-inverting and inverting terminals without damaging the IC.

1.3 Input common-mode voltage range (Vicm)

Signifies the maximum voltage that can be supplied to non-inverting and inverting terminals without causing deterioration of the electrical characteristics or damage to the IC itself. Normal operation is not guaranteed within the input common-mode voltage range of the maximum ratings – use within the input common-mode voltage range of the electric characteristics instead.

1.4 Power dissipation (Pd)

Indicates the power that can be consumed by a particular mounted board at ambient temperature (25°C).
For packaged products, Pd is determined by maximum junction temperature and the thermal resistance.

2. Electrical characteristics

2.1 Input offset voltage (Vio)

Signifies the voltage difference between the non-inverting and inverting terminals. It can be thought of as the input voltage difference required for setting the output voltage to 0V.

2.2 Input offset current (Iio)

Indicates the difference of the input bias current between the non-inverting and inverting terminals.

2.3 Input bias current (Ib)

Denotes the current that flows into or out of the input terminal, it is defined by the average of the input bias current at the non-inverting terminal and the input bias current at the inverting terminal.

2.4 Input common-mode voltage range (Vicm)

Indicates the input voltage range under which the IC operates normally.

2.5 Large signal voltage gain (AV)

The amplifying rate (gain) of the output voltage against the voltage difference between the non-inverting and inverting terminals, it is (normally) the amplifying rate (gain) with respect to DC voltage.
 $AVD = (\text{output voltage fluctuation}) / (\text{input offset fluctuation})$

2.6 Circuit current (ICC)

Indicates the current of the IC itself that flows under specific conditions and during no-load steady state.

2.7 Output sink current (IOL)

Denotes the maximum current that can be output under specific output conditions.

2.8 Output saturation voltage low level output voltage (VOL)

Signifies the voltage range that can be output under specific output conditions.

2.9 Output leakage current (ILeak)

Indicates the current that flows into the IC under specific input and output conditions.

2.10 Response time (tre)

The interval between the application of input and output conditions.

2.11 Common-mode rejection ratio (CMRR)

Denotes the ratio of fluctuation of the input offset voltage when the in-phase input voltage is changed (DC fluctuation).
 $CMRR = (\text{change of input common-mode voltage}) / (\text{input offset fluctuation})$

2.12 Power supply rejection ratio (PSRR)

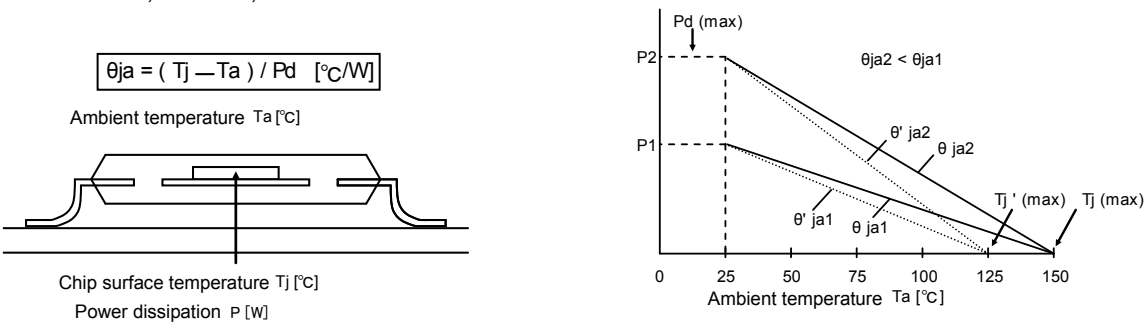
Signifies the ratio of fluctuation of the input offset voltage when the supply voltage is changed (DC fluctuation).
 $PSRR = (\text{change in power supply voltage}) / (\text{input offset fluctuation})$

●Derating curves

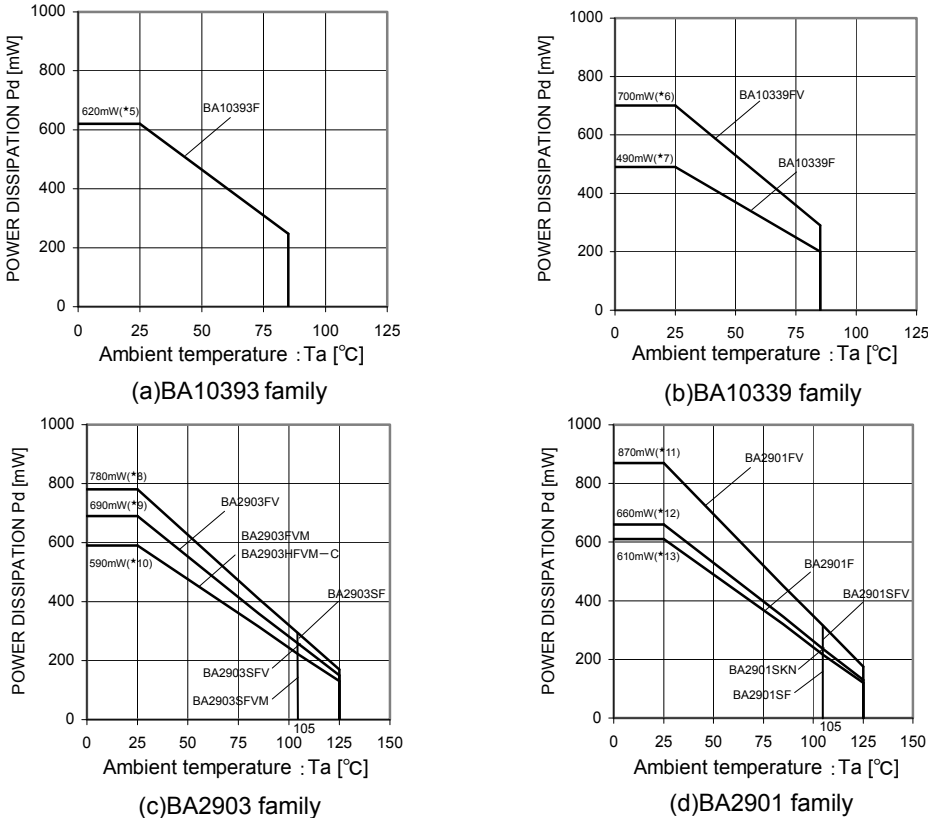
Power dissipation(total loss) indicates the power that can be consumed by IC at Ta=25°C(normal temperature).IC is heated when it consumed power, and the temperature of IC chip becomes higher than ambient temperature.The temperature that can be accepted by IC chip depends on circuit configuration, manufacturing process, and consumable power is limited. Power dissipation is determined by the temperature allowed in IC chip(maximum junction temperature) and thermal resistance of package(heat dissipation capability). The maximum junction temperature is typically equal to the maximum value in the storage temperature range. Heat generated by consumed power of IC radiates from the mold resin or lead frame of the package. The parameter which indicates this heat dissipation capability(hardness of heat release)is called thermal resistance, represented by the symbol θ_{ja} [°C/W].The temperature of IC inside the package can be estimated by this thermal resistance. Fig.91(a) shows the model of thermal resistance of the package. Thermal resistance θ_{ja} , ambient temperature Ta, junction temperature Tj, and power dissipation Pd can be calculated by the equation below:

$$\theta_{ja} = (T_j - T_a) / P_d \quad [^{\circ}\text{C/W}] \quad \cdots \cdots (I)$$

Derating curve in Fig.91(b) indicates power that can be consumed by IC with reference to ambient temperature. Power that can be consumed by IC begins to attenuate at certain ambient temperature. This gradient is determined by thermal resistance θ_{ja} . Thermal resistance θ_{ja} depends on chip size, power consumption, package, ambient temperature, package condition, wind velocity, etc even when the same of package is used. Thermal reduction curve indicates a reference value measured at a specified condition. Fig.92(a)~(d) show a derating curve for an example of BA10393, BA10339, BA2903S, BA2903, BA2903HFVM-C,BA2901S, BA2901.



(a) Thermal resistance (b) Derating curve
Fig.91 Thermal resistance and derating curve



(*5)	(*6)	(*7)	(*8)	(*9)	(*10)	(*11)	(*12)	(*13)	Unit
6.2	7.0	4.9	6.2	5.5	4.7	7.0	5.3	4.9	[mW/°C]

When using the unit above Ta=25[°C], subtract the value above per degree[°C]. Permissible dissipation is the value when glass epoxy board 70[mm]×70[mm]×1.6[mm](cooper foil area below 3[%]) is mounted.

Fig.92 Derating curve

●Precautions

1) Unused circuits

When there are unused circuits it is recommended that they be connected as in Fig.93, setting the non-inverting input terminal to a potential within the in-phase input voltage range (VICR).

2) Input terminal voltage

(BA2903S/BA2903/BA2901S/BA2901 family, BA2903HFVM-C)Applying VEE + 36V to the input terminal is possible without causing deterioration of the electrical characteristics or destruction, irrespective of the supply voltage. However, this does not ensure normal circuit operation.

Please note that the circuit operates normally only when the input voltage is within the common mode input voltage range of the electric characteristics.

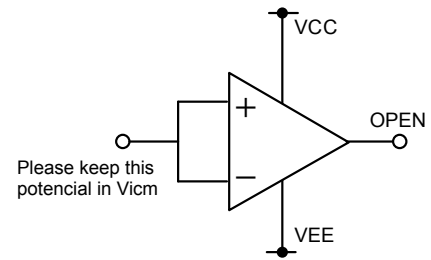


Fig.93 Disable circuit example

3) Power supply (single / dual)

The op-amp operates when the specified voltage supplied is between VCC and VEE. Therefore, the single supply op-amp can be used as a dual supply op-amp as well.

4) Power dissipation Pd

Using the unit in excess of the rated power dissipation may cause deterioration in electrical characteristics due to a rise in chip temperature, including reduced current capability.

Therefore, please take into consideration the power dissipation (Pd) under actual operating conditions and apply a sufficient margin in thermal design. Refer to the thermal derating curves for more information.

5) Short-circuit between pins and erroneous mounting

Incorrect mounting may damage the IC. In addition, the presence of foreign particles between the outputs, the output and the power supply, or the output and GND may result in IC destruction.

6) Terminal short-circuits

When the output and VCC terminals are shorted, excessive output current may flow, resulting in undue heat generation and, subsequently, destruction.

7) Operation in a strong electromagnetic field

Operation in a strong electromagnetic field may cause malfunctions.

8) Radiation

This IC is not designed to withstand radiation.

9) IC handling

Applying mechanical stress to the IC by deflecting or bending the board may cause fluctuations in the electrical characteristics due to piezoelectric (piezo) effects.

10) Board inspection

Connecting a capacitor to a pin with low impedance may stress the IC.

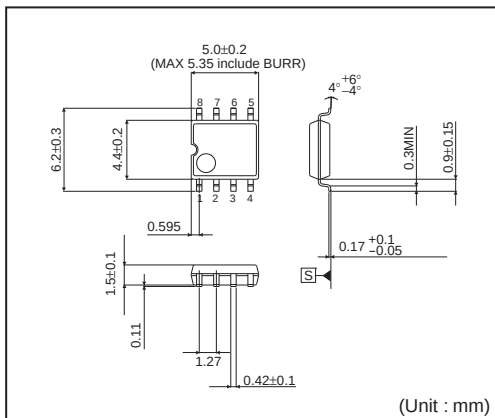
Therefore, discharging the capacitor after every process is recommended. In addition, when attaching and detaching the jig during the inspection phase, ensure that the power is turned off before inspection and removal.

Furthermore, please take measures against ESD in the assembly process as well as during transportation and storage.

●Ordering part number

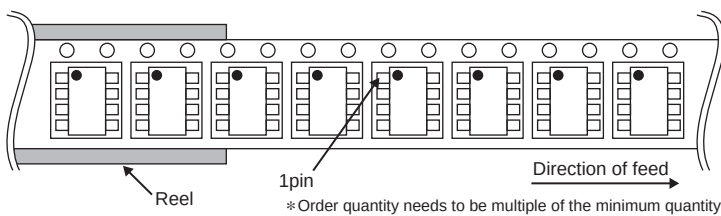
B A	2 9 0 3	F V	- E 2
Part No.	Part No. 10393,1033 2903S,2903 2901S,2901 2903H	Package F: SOP8 SOP14 FV: SSOP-B8 SSOP-B14 FVM: MSOP8 KN:VQFN16	Packaging and forming specification E2: Embossed tape and reel (SOP8/SOP14/SSOP-B8/ SSOP-B14/VQFN16) TR: Embossed tape and reel (MSOP8)

SOP8

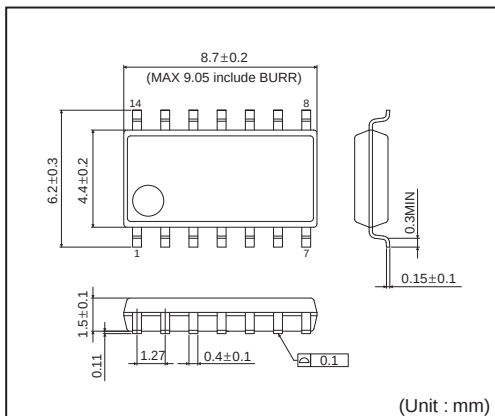


<Tape and Reel information>

Tape	Embossed carrier tape
Quantity	2500pcs
Direction of feed	E2 (The direction is the 1pin of product is at the upper left when you hold reel on the left hand and you pull out the tape on the right hand)

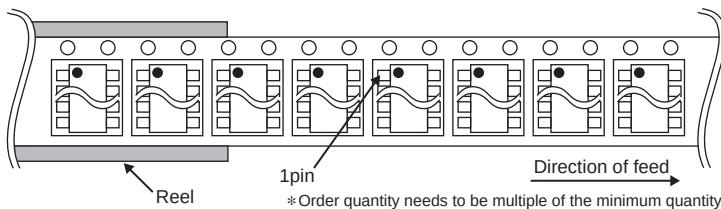


SOP14

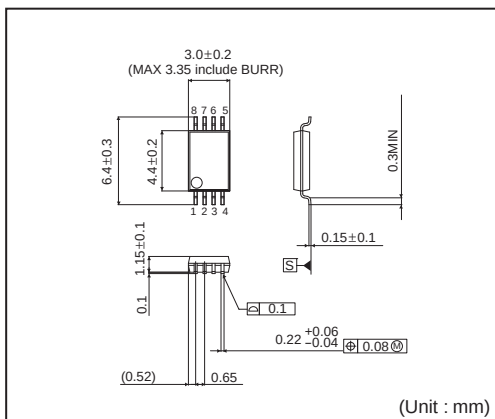


<Tape and Reel information>

Tape	Embossed carrier tape
Quantity	2500pcs
Direction of feed	E2 (The direction is the 1pin of product is at the upper left when you hold reel on the left hand and you pull out the tape on the right hand)

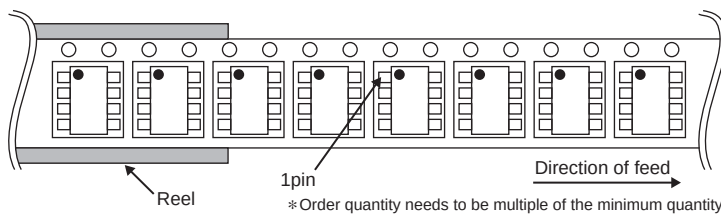


SSOP-B8



<Tape and Reel information>

Tape	Embossed carrier tape
Quantity	2500pcs
Direction of feed	E2 (The direction is the 1pin of product is at the upper left when you hold reel on the left hand and you pull out the tape on the right hand)



Top view dimensions:

- Overall width: 5.0 ± 0.2
- Overall height: 6.4 ± 0.3
- Pin pitch: 0.5
- Pin 14 position: 4.4 ± 0.2 from the left edge
- Pin 8 position: 0.8 from the right edge
- Pin 1 position: 0.1 from the left edge
- Pin 7 position: 0.7 from the right edge

Side view dimensions:

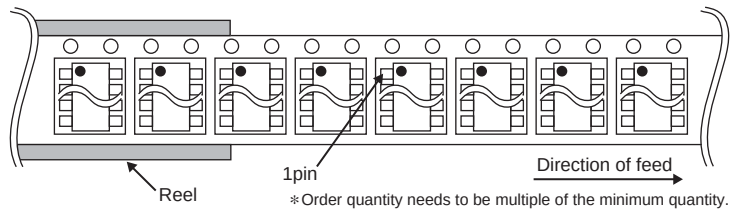
- Pin height: 0.3 Min.
- Mounting tab width: 0.15 ± 0.1

Detail view dimensions:

- Mounting tab height: 1.15 ± 0.1
- Mounting tab thickness: 0.10
- Mounting tab width: 0.65
- Mounting tab hole diameter: 0.1
- Mounting tab hole position: 0.22 ± 0.1 from the center of the pin array

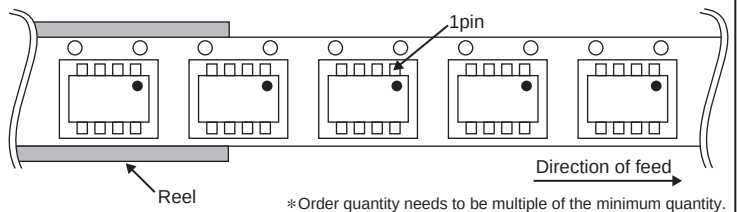
(Unit : mm)

Tape	Embossed carrier tape
Quantity	2500pcs
Direction of feed	E2 (The direction is the 1pin of product is at the upper left when you hold reel on the left hand and you pull out the tape on the right hand)

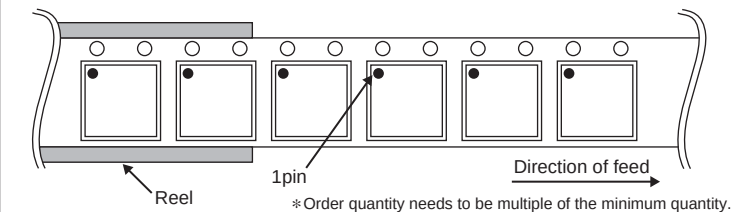


(Unit : mm)

Tape	Embossed carrier tape
Quantity	3000pcs
Direction of feed	TR (The direction is the 1pin of product is at the upper right when you hold reel on the left hand and you pull out the tape on the right hand)

[illegible]

Tape	Embossed carrier tape (with dry pack)
Quantity	2500pcs
Direction of feed	E2 (The direction is the 1pin of product is at the upper left when you hold reel on the left hand and you pull out the tape on the right hand)



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